

0.9-Ω SPST ANALOG SWITCH

Check for Samples: TS5A3167

FEATURES

- Isolation in Powered-Off Mode, V₊ = 0
- Low ON-State Resistance (0.9 Ω)
- Control Inputs Are 5.5-V Tolerant
- · Low Charge Injection
- Low Total Harmonic Distortion (THD)
- 1.65-V to 5.5-V Single-Supply Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)

APPLICATIONS

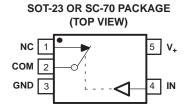
- Cell Phones
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- Low-Voltage Data-Acquisition Systems
- Communication Circuits
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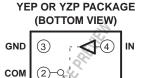
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Microphone Switching – Notebook Docking





DESCRIPTION/ORDERING INFORMATION

The TS5A3167 is a single-pole single-throw (SPST) analog switch that is designed to operate from 1.65 V to 5.5 V. The device offers a low ON-state resistance. The device has excellent total harmonic distortion (THD) performance and consumes very low power. These features make this device suitable for portable audio applications.

ORDERING INFORMATION

T _A	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING (2)
	NanoStar™ – WCSP (DSBGA) 0.23-mm Large Bump – YEP	Tape and reel	TS5A3167YEPR	PACKAGE PREVIEW
	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb- free)	Tape and reel	TS5A3167YZPR	JG_
-40°C to 85°C	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb- free)	Tape and reel	TS5A3167YZPRB ⁽³⁾	JG_
	SOT (SOT-23) – DBV	Tape and reel	TS5A3167DBVR	JAT_
	SOT (SC-70) - DCK	Tape and reel	TS5A3167DCKR	JG_

- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
- (2) DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.
 (3) **YZPRB is for backside coating
 - YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, = Pb-free).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



Summary Of Characteristics⁽¹⁾

Configuration	Single Pole Single Throw (SPST)
Number of channels	1
ON-state resistance (r _{on})	0.9 Ω
ON-state resistance flatness (r _{on(flat)})	0.15 Ω
Turn-on/turn-off time (t _{ON} /t _{OFF})	7.5 ns/12 ns
Charge injection (Q _C)	1 pC
Bandwidth (BW)	200 MHz
OFF isolation (O _{ISO})	-64 dB at 1 MHz
Total harmonic distortion (THD)	0.005%
Leakage current (I _{COM(OFF)})	±20 nA
Power-supply current (I ₊)	0.5 μΑ
Package option	5-pin DSBGA, SOT-23, or SC-70

(1) $V_+ = 5 \text{ V}, T_A = 25^{\circ}\text{C}$

FUNCTION TABLE

IN	NC TO COM, COM TO NC
L	ON
Н	OFF

Absolute Maximum Ratings (1) (2)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V ₊	Supply voltage range ⁽³⁾		-0.5	6.5	V
$V_{NC} \ V_{COM}$	Analog voltage range ⁽³⁾ (4) (5)		-0.5	V ₊ + 0.5	٧
I _K	Analog port diode current	$V_{NC}, V_{COM} < 0$	-50		mA
I _{NC}	On-state switch current	V V 0 to V	-200	200	A
I _{COM}	On-state peak switch current (6)	V_{NC} , $V_{COM} = 0$ to V_+	-400	400	mA
VI	Digital input voltage range (3) (4)	•	-0.5	6.5	V
I _{IK}	Digital clamp current	V _I < 0	-50		mA
I ₊	Continuous current through V ₊			100	mA
I _{GND}	Continuous current through GND		-100		mA
		DBV package		206	
θ_{JA}	Package thermal impedance ⁽⁷⁾	DCK package		252	°C/W
		YEP/YZP package		132	
T _{stg}	Storage temperature range		-65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
- (3) All voltages are with respect to ground, unless otherwise specified.
- (4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- (5) This value is limited to 5.5 V maximum.
- (6) Pulse at 1-ms duration < 10% duty cycle.
- (7) The package thermal impedance is calculated in accordance with JESD 51-7.



Electrical Characteristics for 5-V Supply⁽¹⁾

 $V_{+} = 4.5 \text{ V to } 5.5 \text{ V}, T_{A} = -40^{\circ}\text{C to } 85^{\circ}\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDIT	TIONS	TA	V ₊	MIN	TYP	MAX	UNIT
Analog Switch		1		1.	II.				
Analog signal range	V_{COM} , V_{NC}					0		V+	V
Peak ON resistance	r _{peak}	$0 \le V_{NC} \le V_{+},$ $I_{COM} = -100 \text{ mA},$	Switch ON, See Figure 13	25°C	4.5 V		0.8	1.1	Ω
	·			Full				1.2	
ON-state resistance	r _{on}	$V_{NC} = 2.5 \text{ V},$ $I_{COM} = -100 \text{ mA},$	Switch ON, See Figure 13	25°C Full	4.5 V		0.75	0.9	Ω
ON-state resistance		$0 \le V_{NC} \le V_+,$ $I_{COM} = -100 \text{ mA},$	Switch ON,	25°C			0.2		
flatness	$r_{on(flat)}$	V _{NC} = 1 V, 1.5 V, 2.5 V,	See Figure 13	25°C 4.5 V		0.15	0.25	Ω	
		$I_{COM} = -100 \text{ mA},$		Full				0.25	
		$V_{NC} = 1 V$,		25°C		0 V	4	20	
NC OFF leakage current	I _{NC(OFF)}	$V_{COM} = 4.5 \text{ V},$ or $V_{NC} = 4.5 \text{ V},$ $V_{COM} = 1 \text{ V},$	Switch OFF, See Figure 14	Full	5.5 V	-150		150	nA
-		$V_{NC} = 0 \text{ to } 5.5 \text{ V},$		25°C	0.1/	-10	0.2	10	
	I _{NC(PWROFF)}	$V_{COM} = 5.5 \text{ V to } 0,$		Full	0 V	-50		50 µA	μΑ
		V _{COM} = 1 V,		25°C		0 V	4	20	
COM OFF leakage current	I _{COM(OFF)}	$V_{NC} = 4.5 \text{ V},$ or $V_{COM} = 4.5 \text{ V},$ $V_{NC} = 1 \text{ V},$	Switch OFF, See Figure 14	Full	5.5 V	-150		150	nA
		$V_{COM} = 5.5 \text{ V to } 0,$		25°C	0.1/	-10	0.2	10	
	I _{COM(PWROFF)}	$V_{NC} = 0 \text{ to } 5.5 \text{ V},$		Full	0 V	-50		50	μΑ
		V _{NC} = 1 V,		25°C		-5	0.4	5	
NC ON leakage current	I _{NC(ON)}	$V_{COM} = Open,$ or $V_{NC} = 4.5 \text{ V},$ $V_{COM} = Open,$	Switch ON, See Figure 15	Full	5.5 V	-50		50	nA
		$V_{COM} = 1 V$,		25°C		-5	0.4	5	
COM ON leakage current	I _{COM(ON)}	V_{NC} = Open, or V_{COM} = 4.5 V, V_{NC} = Open,	Switch ON, See Figure 15	Full	5.5 V	-20		20	nA
Digital Control Input	s (IN1, IN2)			•	•	•			
Input logic high	V _{IH}			Full		2.4		5.5	V
Input logic low	V_{IL}			Full		0		0.8	V
Input leakage	1 1	V FFV or 0		25°C	E C V	-2	0.3	2	A
current	$I_{IH},\ I_{IL}$	$V_1 = 5.5 \text{ V or } 0$		Full	5.5 V	-20		20	nA

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.



Electrical Characteristics for 5-V Supply⁽¹⁾ (continued)

 $V_{+} = 4.5 \text{ V to } 5.5 \text{ V}, T_{A} = -40^{\circ}\text{C to } 85^{\circ}\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST C	ONDITIONS	T _A	V+	MIN	TYP	MAX	UNIT
Dynamic								,	
		V V	C 25 pF	25°C	5 V	1	4.5	7.5	
Turn-on time	t _{ON}	$V_{COM} = V_+,$ $R_L = 50 \Omega,$	C _L = 35 pF, See Figure 17	Full	4.5 V to 5.5 V	1		9	ns
		\/ \/	0 25 -5	25°C	5 V	4.5	8	11	
Turn-off time	t _{OFF}	$V_{COM} = V_+,$ $R_L = 50 \Omega,$	C _L = 35 pF, See Figure 17	Full	4.5 V to 5.5 V	3.5		13	ns
Charge injection	Q _C	$V_{GEN} = 0,$ $R_{GEN} = 0$,	C _L = 1 nF, See Figure 21	25°C	5 V		6		рС
NC OFF capacitance	C _{NC(OFF)}	V _{NC} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	5 V		19		pF
COM OFF capacitance	C _{COM(OFF)}	V _{COM} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	5 V		18		pF
NC ON capacitance	C _{NC(ON)}	V _{NC} = V ₊ or GND, Switch ON,	See Figure 16	25°C	5 V		35.5		pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	See Figure 16	25°C	5 V		35.5		pF
Digital input capacitance	Cı	$V_I = V_+ \text{ or GND},$	See Figure 16	25°C	5 V		2		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 18	25°C	5 V		150		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, f = 1 MHz,	Switch OFF, See Figure 19	25°C	5 V		-62		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 21	25°C	5 V		0.005		%
Supply	•			•	•			'	
Positive supply		V V or CND	Switch ON or OFF	25°C	5.5 V		0.01	0.1	
current	I ₊	$V_I = V_+ \text{ or GND},$	SWILCH ON OF OFF	Full	5.5 V		-	1	μΑ

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



Electrical Characteristics for 3.3-V Supply⁽¹⁾

 $V_{+} = 3 \text{ V to } 3.6 \text{ V}, T_{A} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C} \text{ (unless otherwise noted)}$

PARAMETER	SYMBOL	TEST CONDITIONS		T _A	V ₊	MIN	TYP	MAX	UNIT
Analog Switch								'	
Analog signal range	V _{COM} , V _{NC}					0		V ₊	V
Peak ON resistance	r	$0 \le V_{NC} \le V_+$	Switch ON,	25°C	3 V		1.3	1.6	Ω
T can on resistance	r _{peak}	$I_{COM} = -100 \text{ mA},$	See Figure 13	Full	0 1			1.8	32
ON-state resistance	r _{on}	$V_{NC} = 2 V$,	Switch ON,	25°C	3 V		1.1	1.5	Ω
	-011	$I_{COM} = -100 \text{ mA},$	See Figure 13	Full				1.7	
ON-state resistance	_	$0 \le V_{NC} \le V_+,$ $I_{COM} = -100 \text{ mA},$	Switch ON,	25°C	2.1/		0.3		0
flatness	r _{on(flat)}	$V_{NC} = 2 \text{ V}, 0.8 \text{ V},$	See Figure 13	25°C	3 V		0.15	0.25	Ω
		$I_{COM} = -100 \text{ mA},$		Full				0.25	
		$V_{NC} = 1 V$		25°C		- 5	0.5	5	
NC OFF leakage current	I _{NC(OFF)}	$V_{COM} = 3 \text{ V},$ or $V_{NC} = 3 \text{ V},$ $V_{COM} = 1 \text{ V},$	Switch OFF, See Figure 14	Full	3.6 V	-50		50	nA
		$V_{NC} = 0 \text{ to } 3.6 \text{ V},$		25°C	0.1/	-5	0.1	5	
	I _{NC(PWROFF)}	$V_{COM} = 3.6 \text{ V to 0},$		Full	0 V	-25		25	μΑ
		$V_{COM} = 1 V$,		25°C		-5	0.5	5	
COM OFF leakage current	I _{COM(OFF)}	$V_{NC} = 3 V$, or $V_{COM} = 3 V$, $V_{NC} = 1 V$,	Switch OFF, See Figure 14	Full	3.6 V	-50		50	nA
		$V_{COM} = 3.6 \text{ V to } 0,$		25°C	0 V	- 5	0.1	5	
	ICOM(PWROFF)	$V_{NC} = 0 \text{ to } 3.6 \text{ V},$		Full	UV	-25		25	μA
		$V_{NC} = 1 V$		25°C		-2	0.3	2	
NC ON leakage current	I _{NC(ON)}	$V_{COM} = Open,$ or $V_{NC} = 3 V,$ $V_{COM} = Open,$	Switch ON, See Figure 15	Full	3.6 V	-20		20	nA
		$V_{COM} = 1 V$,		25°C		-2	0.3	2	
COM ON leakage current	I _{COM(ON)}	V _{NC} = Open, or V _{COM} = 3 V, V _{NC} = Open,	Switch ON, See Figure 15	Full	3.6 V	-20		20	nA
Digital Control Inputs	(IN1, IN2)	•			•			'	
Input logic high	V _{IH}			Full		2		5.5	V
Input logic low	V _{IL}			Full		0		8.0	٧
Input lookogo ourrent	1 1	V - 5 5 V or 0		25°C	261/	-2	0.3	2	nΛ
Input leakage current	I _{IH} , I _{IL}	$V_1 = 5.5 \text{ V or } 0$		Full	3.6 V	-20		20	nA

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



Electrical Characteristics for 3.3-V Supply⁽¹⁾ (continued)

 $V_{+} = 3 \text{ V to } 3.6 \text{ V}, T_{A} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C} \text{ (unless otherwise noted)}$

PARAMETER	SYMBOL	TEST CO	ONDITIONS	T_A	V+	MIN	TYP	MAX	UNIT
Dynamic									
		\/ -\/	$C_1 = 35 pF$	25°C	3.3 V	1.5	5	9.5	
Turn-on time	t _{ON}	$V_{COM} = V_+,$ $R_L = 50 \Omega,$	See Figure 17	Full	3 V to 3.6 V	1.0		10	ns
		V V	$C_1 = 35 pF$	25°C	3.3 V	4.5	8.5	11	
Turn-off time	t _{OFF}	$V_{COM} = V_+,$ $R_L = 50 \Omega,$	See Figure 17	Full	3 V to 3.6 V	3		12.5	ns
Charge injection	$Q_{\mathbb{C}}$	$V_{GEN} = 0,$ $R_{GEN} = 0,$	$C_L = 1 \text{ nF},$ See Figure 21	25°C	3.3 V		6		рС
NC OFF capacitance	C _{NC(OFF)}	V _{NC} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	3.3 V		19.5		pF
COM OFF capacitance	C _{COM(OFF)}	V _{COM} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	3.3 V		18.5		pF
NC ON capacitance	C _{NC(ON)}	V _{NC} = V ₊ or GND, Switch ON,	See Figure 16	25°C	3.3 V		36		pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	See Figure 16	25°C	3.3 V		36		pF
Digital input capacitance	C _I	$V_I = V_+ \text{ or GND},$	See Figure 16	25°C	3.3 V		2		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 18	25°C	3.3 V		150		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, f = 1 MHz,	Switch OFF, See Figure 19	25°C	3.3 V		-62		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 21	25°C	3.3 V		0.01		%
Supply									
Positive supply		$V_1 = V_+$ or GND,	Switch ON or OFF	25°C	3.6 V		0.001	0.05	
current	I ₊	$v_1 = v_+ \cup i \cup i \cup i$	SWILCH ON OF OFF	Full	3.0 V			0.3	μA

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

Product Folder Links: TS5A3167



Electrical Characteristics for 2.5-V Supply⁽¹⁾

 $\mbox{V}_{+} = 2.3 \mbox{ V to } 2.7 \mbox{ V}, \mbox{ } \mbox{T}_{\mbox{\scriptsize A}} = -40 \mbox{\ensuremath{^{\circ}}}\mbox{C} \mbox{ to } 85 \mbox{\ensuremath{^{\circ}}}\mbox{C} \mbox{ (unless otherwise noted)}$

PARAMETER	SYMBOL	TEST CON	TEST CONDITIONS T		V ₊	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V _{COM} , V _{NC}				2.3 V	0		V ₊	V
Peak ON resistance	r _{peak}	$0 \le V_{NC} \le V_{+},$ $I_{COM} = -100 \text{ mA},$	Switch ON, See Figure 13	25°C Full	2.3 V		1.8	2.4	Ω
ON-state resistance	r _{on}	$V_{NC} = 2 V$, $I_{COM} = -100 \text{ mA}$,	Switch ON, See Figure 13	25°C Full	2.3 V		1.2	2.1 2.4	Ω
ON-state resistance		$0 \le V_{NC} \le V_{+},$ $I_{COM} = -100 \text{ mA},$	Switch ON,	25°C			0.7		_
flatness	r _{on(flat)}	$V_{NC} = 2 \text{ V}, 0.8 \text{ V},$ $I_{COM} = -100 \text{ mA},$	See Figure 13	25°C Full	2.3 V		0.4	0.6	Ω
		$V_{NC} = 1 \text{ V},$		25°C		- 5	0.3	5	
NC OFF leakage current	I _{NC(OFF)}	V _{COM} = 3 V, or V _{NC} = 3 V, V _{COM} = 1 V,	Switch OFF, See Figure 14	Full	2.7 V	-50	0.0	50	nA
		$V_{NC} = 0 \text{ to } 3.6 \text{ V},$		25°C	0.17	-2	0.05	2	
	I _{NC(PWROFF)}	$V_{COM} = 3.6 \text{ V to } 0,$		Full	0 V	-15		15	μΑ
		$V_{COM} = 1 V$,		25°C		-5	0.3	5	
COM OFF leakage current	I _{COM(OFF)}	$V_{NC} = 3 V$, or $V_{COM} = 3 V$, $V_{NC} = 1 V$,	Switch OFF, See Figure 14	Full	2.7 V	-50		50	nA
		$V_{COM} = 3.6 \text{ V to 0},$		25°C	0.17	-2	0.05	2	0
	I _{COM(PWROFF)}	$V_{NC} = 0 \text{ to } 3.6 \text{ V},$		Full	0 V	-15		15	μΑ
		V _{NC} = 1 V,		25°C		-2	0.3	2	
NC ON leakage current	I _{NC(ON)}	$V_{COM} = Open,$ or $V_{NC} = 3 V,$ $V_{COM} = Open,$	Switch ON, See Figure 15	Full	2.7 V	-20		20	nA
		$V_{COM} = 1 V$,		25°C		-2	0.3	2	
COM ON leakage current	I _{COM(ON)}	$V_{NC} = Open,$ or $V_{COM} = 3 V,$ $V_{NC} = Open,$	Switch ON, See Figure 15	Full	2.7 V	-20		20	nA
Digital Control Inputs	(IN1, IN2)	•			•				
Input logic high	V _{IH}			Full		1.8		5.5	V
Input logic low	V _{IL}			Full		0		0.6	V
Innut looke	, ,	V		25°C	0.7.1/	-2	0.3	2	m ^
Input leakage current	I _{IH} , I _{IL}	$V_1 = 5.5 \text{ V or } 0$		Full	2.7 V	-20		20	nA

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



Electrical Characteristics for 2.5-V Supply⁽¹⁾ (continued)

 $V_{+} = 2.3 \text{ V to } 2.7 \text{ V}, T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C} \text{ (unless otherwise noted)}$

PARAMETER	SYMBOL	TEST CC	ONDITIONS	T_A	V+	MIN	TYP	MAX	UNIT
Dynamic	<u> </u>								
		\/ -\/	$C_1 = 35 \text{ pF},$	25°C	2.5 V	2	6	10	
Turn-on time	t _{ON}	$V_{COM} = V_+,$ $R_L = 50 \Omega,$	See Figure 17	Full	2.3 V to 2.7 V	1		12	ns
		V V	C 25 pF	25°C	2.5 V	4.5	8	10.5	
Turn-off time	t _{OFF}	$V_{COM} = V_+,$ $R_L = 50 \Omega,$	C _L = 35 pF, See Figure 17	Full	2.3 V to 2.7 V	3		15	ns
Charge injection	$Q_{\mathbb{C}}$	$V_{GEN} = 0,$ $R_{GEN} = 0,$	$C_L = 1 \text{ nF},$ See Figure 21	25°C	2.5 V		4		рС
NC OFF capacitance	C _{NC(OFF)}	V _{NC} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	2.5 V		19.5		pF
COM OFF capacitance	C _{COM(OFF)}	V _{COM} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	2.5 V		18.5		pF
NC ON capacitance	C _{NC(ON)}	$V_{NC} = V_{+}$ or GND, Switch ON,	See Figure 16	25°C	2.5 V		36.5		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = V_{+}$ or GND, Switch ON,	See Figure 16	25°C	2.5 V		36.5		pF
Digital input capacitance	C _I	$V_I = V_+ \text{ or GND},$	See Figure 16	25°C	2.5 V		2		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 18	25°C	2.5 V		150		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, f = 1 MHz,	Switch OFF, See Figure 19	25°C	2.5 V		-62		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 21	25°C	2.5 V		0.02		%
Supply				-					
Positive supply		$V_1 = V_+ \text{ or GND},$	Switch ON or OFF	25°C	2.7 V		0.001	0.02	^
current	I ₊	v - v+ or GIVD,	SWILCH ON OF OFF	Full	Z.1 V			0.25	μΑ

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



Electrical Characteristics for 1.8-V Supply⁽¹⁾

 V_{+} = 1.65 V to 1.95 V, T_{A} = -40°C to 85°C (unless otherwise noted))

PARAMETER	SYMBOL	TEST CONDITIONS		T _A	V ₊	MIN	TYP	MAX	UNIT
Analog Switch				.	.				
Analog signal range	V _{COM} , V _{NC}					0		V ₊	V
Peak ON resistance	_	$0 \le V_{NC} \le V_+$	Switch ON,	25°C	1.65 V		4.2	25	Ω
Peak On resistance	r _{peak}	$I_{COM} = -100 \text{ mA},$	See Figure 13	Full	1.00 V			30	12
ON-state resistance	-	$V_{NC} = 2 V$,	Switch ON,	25°C	1.65 V		1.6	3.9	Ω
ON-State resistance	r _{on}	$I_{COM} = -100 \text{ mA},$	See Figure 13	Full	1.05 V			4.0	12
ON-state resistance		$0 \le V_{NC} \le V_+,$ $I_{COM} = -100 \text{ mA},$	Switch ON,	25°C			2.8		
flatness	r _{on(flat)}	$V_{NC} = 2 \text{ V}, 0.8 \text{ V},$	See Figure 13	25°C	1.65 V		4.1	22	Ω
		$I_{COM} = -100 \text{ mA},$		Full				27	
		$V_{NC} = 1 V$,		25°C		-5		5	
NC OFF leakage current	I _{NC(OFF)}	$V_{COM} = 3 \text{ V},$ or $V_{NC} = 3 \text{ V},$ $V_{COM} = 1 \text{ V},$	Switch OFF, See Figure 14	Full	1.95 V	-50		50	nA
		$V_{NC} = 0 \text{ to } 3.6 \text{ V},$		25°C	0.1/	-2		2	
	I _{NC(PWROFF)}	$V_{COM} = 3.6 \text{ V to 0},$		Full	0 V	-10		10	μA
		$V_{COM} = 1 V$,		25°C		-5		5	
COM OFF leakage current	I _{COM(OFF)}	$V_{NC} = 3 V$, or $V_{COM} = 3 V$, $V_{NC} = 1 V$,	Switch OFF, See Figure 14	Full	1.95 V	-50		50	nA
	,	$V_{COM} = 0 \text{ to } 3.6 \text{ V},$		25°C	0.1/	-2		2	
	I _{COM(PWROFF)}	$V_{NC} = 3.6 \text{ V to 0},$		Full	0 V	-10		10	μA
		V _{NC} = 1 V,		25°C		-2		2	
NC ON leakage current	I _{NC(ON)}	$V_{COM} = Open,$ or $V_{NC} = 3 V,$ $V_{COM} = Open,$	Switch ON, See Figure 15	Full	1.95 V	-20		20	nA
		$V_{COM} = 1 V$,		25°C		-2		2	
COM ON leakage current	I _{COM(ON)}	$V_{NC} = Open,$ or $V_{COM} = 3 V,$ $V_{NC} = Open,$	Switch ON, See Figure 15	Full	1.95 V	-20		20	nA
Digital Control Inputs	(IN1, IN2)	1		•					
Input logic high	V _{IH}			Full		1.5		5.5	V
Input logic low	V _{IL}			Full		0		0.6	V
lanut lankana august		V 55V 270		25°C	4.05.\/	-2	0.3	2	^
Input leakage current	I _{IH} , I _{IL}	$V_1 = 5.5 \text{ V or } 0$		Full	1.95 V	-20		20	nA

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



Electrical Characteristics for 1.8-V Supply⁽¹⁾ (continued)

 V_{+} = 1.65 V to 1.95 V, T_{A} = -40°C to 85°C (unless otherwise noted))

PARAMETER	SYMBOL	TEST CO	ONDITIONS	TA	V+	MIN	TYP	MAX	UNIT
Dynamic		ı							
		W W	0 25 25	25°C	1.8 V	3	9	18	
Turn-on time	t _{ON}	$V_{COM} = V_+,$ $R_L = 50 \Omega,$	C _L = 35 pF, See Figure 17	Full	1.65 V to 1.95 V	1		20	ns
		V V	C 25 nF	25°C	1.8 V	5	10	15.5	
Turn-off time	t _{OFF}	$V_{COM} = V_+,$ $R_L = 50 \Omega,$	C _L = 35 pF, See Figure 17	Full	1.65 V to 1.95 V	4		18.5	ns
Charge injection	Q _C	$V_{GEN} = 0,$ $R_{GEN} = 0,$	C _L = 1 nF, See Figure 21	25°C	1.8 V		2		рС
NC OFF capacitance	C _{NC(OFF)}	$V_{NC} = V_{+}$ or GND, Switch OFF,	See Figure 16	25°C	1.8 V		19.5		pF
COM OFF capacitance	C _{COM(OFF)}	V _{COM} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	1.8 V		18.5		pF
NC ON capacitance	C _{NC(ON)}	$V_{NC} = V_{+}$ or GND, Switch ON,	See Figure 16	25°C	1.8 V		36.5		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = V_{+}$ or GND, Switch ON,	See Figure 16	25°C	1.8 V		36.5		pF
Digital input capacitance	C _I	$V_I = V_+ \text{ or GND},$	See Figure 16	25°C	1.8 V		2		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	See Figure 18	25°C	1.8 V		150		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, f = 1 MHz,	Switch OFF, See Figure 19	25°C	1.8 V		-62		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz See Figure 21	25°C	1.8 V		0.055		%
Supply									
Positive supply	I ₊	$V_1 = V_+$ or GND,	Switch ON or OFF	25°C	1.95 V		0.001	0.01	μA
current	'+	v - v+ or GIND,	SWILCH ON OF OFF	Full	1.55 V			0.15	μΛ

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

Product Folder Links: TS5A3167



TYPICAL PERFORMANCE

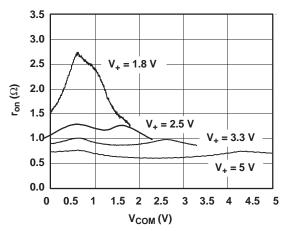


Figure 1. ron vs V_{COM}

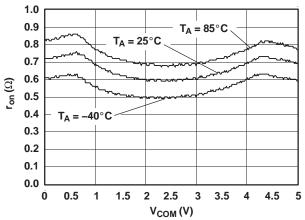


Figure 3. r_{on} vs V_{COM} ($V_{+} = 5 V$)

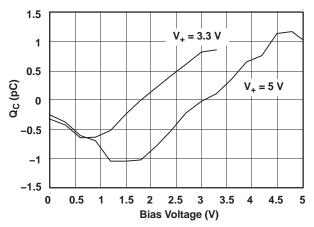


Figure 5. Charge Injection (Q_C) vs V_{COM}

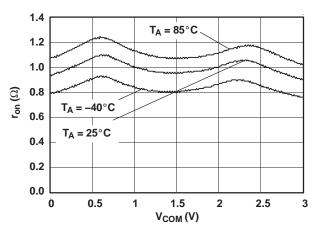


Figure 2. r_{on} vs V_{COM} ($V_{+} = 3 \text{ V}$)

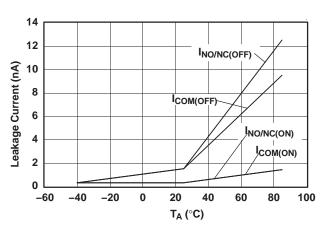


Figure 4. Leakage Current vs Temperature (V₊ = 5.5 V)

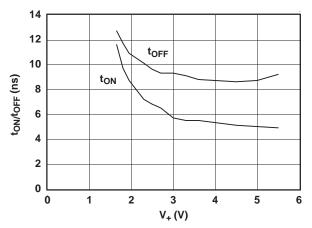
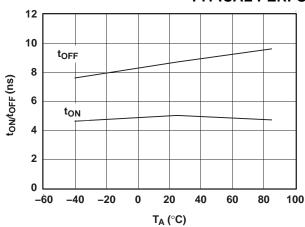


Figure 6. t_{ON} and t_{OFF} vs Supply Voltage







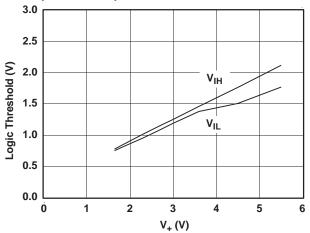
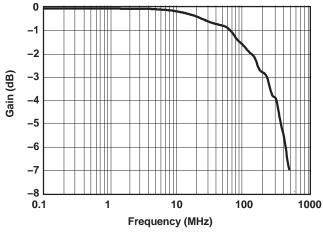


Figure 7. t_{ON} and t_{OFF} vs Temperature (V₊ = 5 V)

Figure 8. Logic Threshold vs V₊



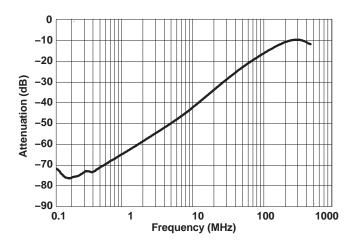
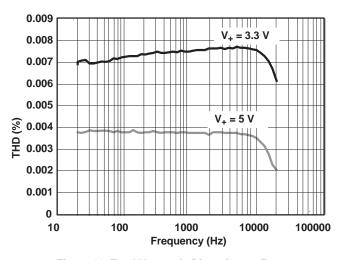


Figure 9. Gain vs Frequency $(V_+ = 5 V)$

Figure 10. OFF Isolation vs Frequency $(V_+ = 5 \text{ V})$



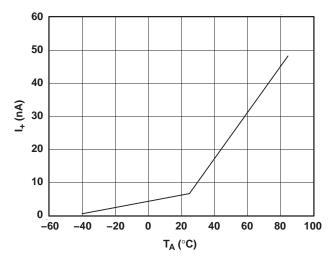


Figure 11. Total Harmonic Distortion vs Frequency $(V_+ = 5 \text{ V})$

Figure 12. Power-Supply Current vs Temperature $(V_+ = 5 \text{ V})$



PIN DESCRIPTION

PIN NUMBER	NAME	DESCRIPTION				
1	NC	Normally close				
2	COM	Common				
3	GND	Digital ground				
4	IN	Digital control pin to connect COM to NC				
5	V ₊	Power Supply				

PARAMETER DESCRIPTION

SYMBOL	DESCRIPTION
V_{COM}	Voltage at COM
V _{NC}	Voltage at NC
r _{on}	Resistance between COM and NC ports when the channel is ON
r _{peak}	Peak on-state resistance over a specified voltage range
r _{on(flat)}	Difference between the maximum and minimum value of ron in a channel over the specified range of conditions
I _{NC(OFF)}	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the OFF state under worst-case input and output conditions
I _{NC(PWROFF)}	Leakage current measured at the NC port during the power-down condition, V ₊ = 0
I _{COM(OFF)}	Leakage current measured at the COM port, with the corresponding channel (COM to NC) in the OFF state under worst-case input and output conditions
I _{COM(PWROFF)}	Leakage current measured at the COM port during the power-down condition, $V_{+} = 0$
I _{NC(ON)}	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the ON state and the output (COM) open
I _{COM(ON)}	Leakage current measured at the COM port, with the corresponding channel (COM to NC) in the ON state and the output (NC) open
V_{IH}	Minimum input voltage for logic high for the control input (IN)
V_{IL}	Maximum input voltage for logic low for the control input (IN)
V_{I}	Voltage at the control input (IN)
I_{IH},I_{IL}	Leakage current measured at the control input (IN)
t _{ON}	Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NC) signal when the switch is turning ON.
t _{OFF}	Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NC) signal when the switch is turning OFF.
$Q_{\mathbb{C}}$	Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NC or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_{COM}$, C_L is the load capacitance, and ΔV_{COM} is the change in analog output voltage.
C _{NC(OFF)}	Capacitance at the NC port when the corresponding channel (NC to COM) is OFF
C _{COM(OFF)}	Capacitance at the COM port when the corresponding channel (COM to NC) is OFF
C _{NC(ON)}	Capacitance at the NC port when the corresponding channel (NC to COM) is ON
C _{COM(ON)}	Capacitance at the COM port when the corresponding channel (COM to NC) is ON
C _I	Capacitance of control input (IN)
O _{ISO}	OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NC to COM) in the OFF state.
BW	Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.
THD	Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic.
I ₊	Static power-supply current with the control (IN) pin at V ₊ or GND



PARAMETER MEASUREMENT INFORMATION

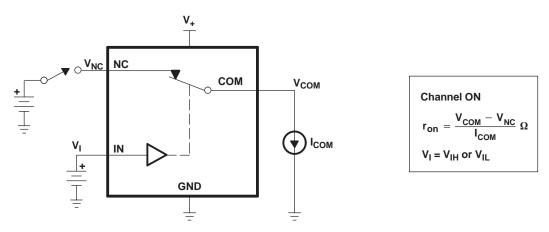


Figure 13. ON-State Resistance (ron)

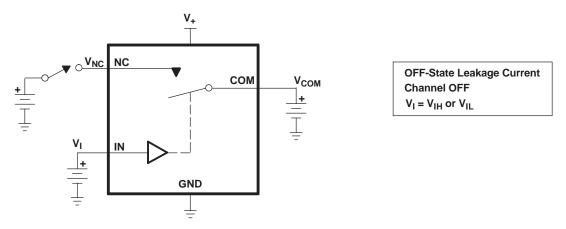


Figure 14. OFF-State Leakage Current ($I_{COM(OFF)}$, $I_{NC(OFF)}$, $I_{COM(PWROFF)}$, $I_{NC(PWR(FF))}$)

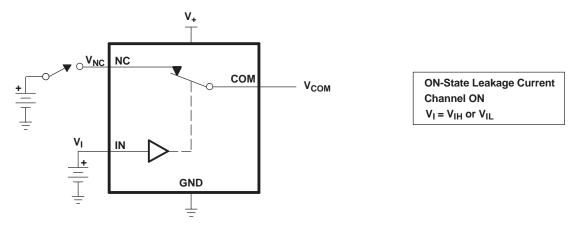


Figure 15. ON-State Leakage Current (I_{COM(ON)}, I_{NC(ON)})



PARAMETER MEASUREMENT INFORMATION (continued)

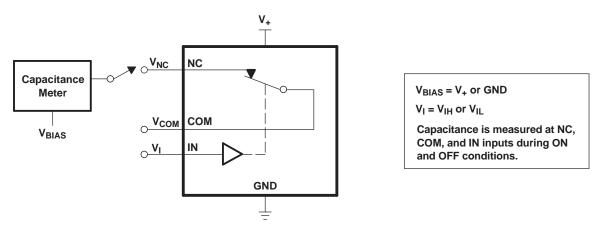
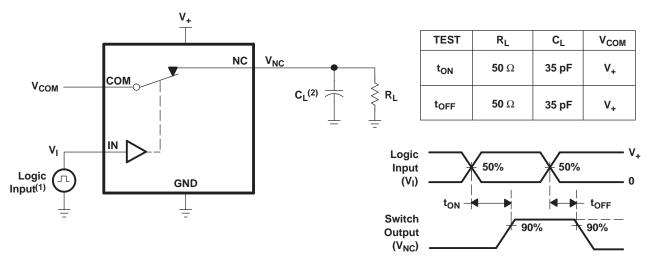


Figure 16. Capacitance (C_I, C_{COM(OFF)}, C_{COM(ON)}, C_{NC(OFF)}, C_{NC(ON)})



- (1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r < 5 \text{ ns}$, $t_f < 5 \text{ ns}$.
- (2) C_L includes probe and jig capacitance.

Figure 17. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})

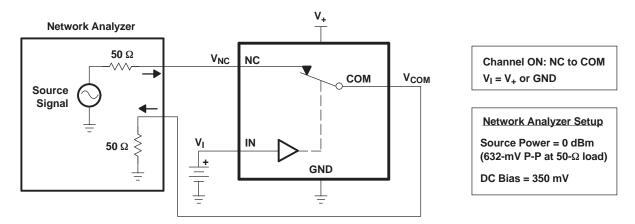


Figure 18. Bandwidth (BW)



PARAMETER MEASUREMENT INFORMATION (continued)

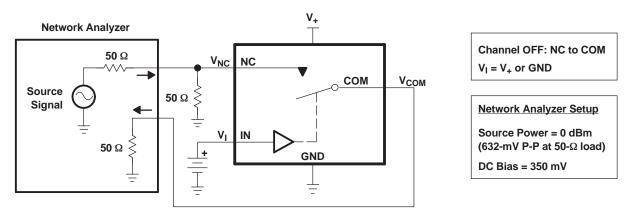
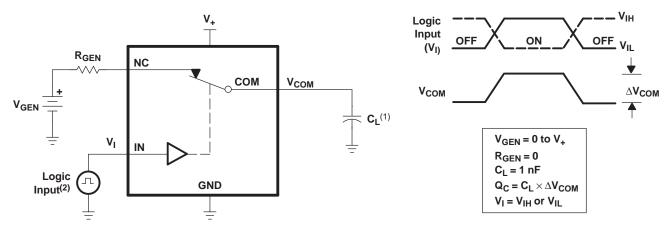
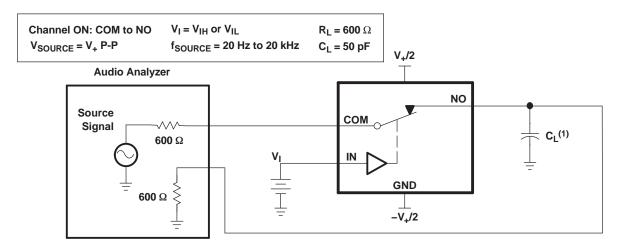


Figure 19. OFF Isolation (O_{ISO})



- (1) C_L includes probe and jig capacitance.
- (2) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r < 5 \text{ ns}$, $t_f < 5 \text{ ns}$.

Figure 20. Charge Injection (Q_C)



(1) C_L includes probe and jig capacitance.

Figure 21. Total Harmonic Distortion (THD)

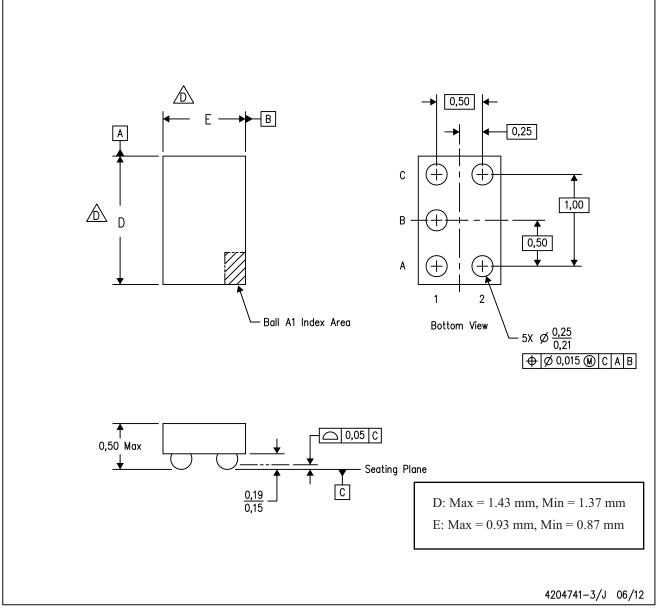


REVISION HISTORY

Cł	hanges from Original (February 2005) to Revision A	Page
•	Updated ORDERING INFORMATION table.	1

YZP (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. NanoFree™ package configuration.
- The package size (Dimension D and E) of a particular device is specified in the device Product Data Sheet version of this drawing, in case it cannot be found in the product data sheet please contact a local TI representative.
- E. This package is a Pb-free solder ball design. Refer to the 5 YEP package (drawing 4204725) for tin-lead (SnPb).

NanoFree is a trademark of Texas Instruments.







10-Jun-2014

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TS5A3167DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JATF ~ JATR)	Samples
TS5A3167DBVRE4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JATF ~ JATR)	Samples
TS5A3167DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JATF ~ JATR)	Samples
TS5A3167DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JG5 ~ JGF ~ JGR)	Samples
TS5A3167DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JG5 ~ JGF ~ JGR)	Samples
TS5A3167YZPR	ACTIVE	DSBGA	YZP	5	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 85	(JG7 ~ JGN)	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



PACKAGE OPTION ADDENDUM

10-Jun-2014

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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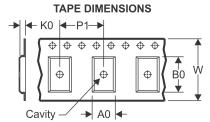
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PACKAGE MATERIALS INFORMATION

www.ti.com 23-Aug-2014

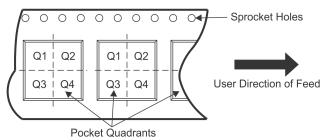
TAPE AND REEL INFORMATION





Α0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TS5A3167DBVR	SOT-23	DBV	5	3000	180.0	8.4	3.23	3.17	1.37	4.0	8.0	Q3
TS5A3167DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TS5A3167DCKR	SC70	DCK	5	3000	180.0	8.4	2.47	2.3	1.25	4.0	8.0	Q3
TS5A3167DCKR	SC70	DCK	5	3000	178.0	9.2	2.4	2.4	1.22	4.0	8.0	Q3
TS5A3167DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TS5A3167YZPR	DSBGA	YZP	5	3000	178.0	9.2	1.02	1.52	0.63	4.0	8.0	Q1

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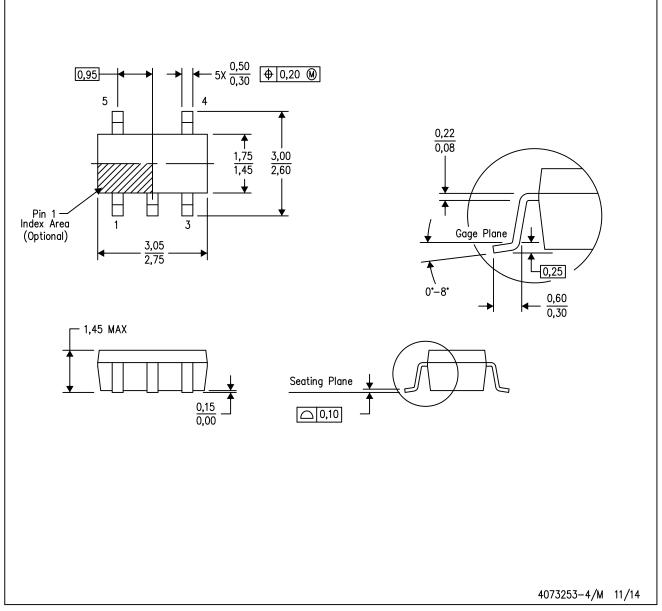


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TS5A3167DBVR	SOT-23	DBV	5	3000	202.0	201.0	28.0
TS5A3167DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TS5A3167DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TS5A3167DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TS5A3167DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TS5A3167YZPR	DSBGA	YZP	5	3000	220.0	220.0	35.0

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-178 Variation AA.



DBV (R-PDSO-G5)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



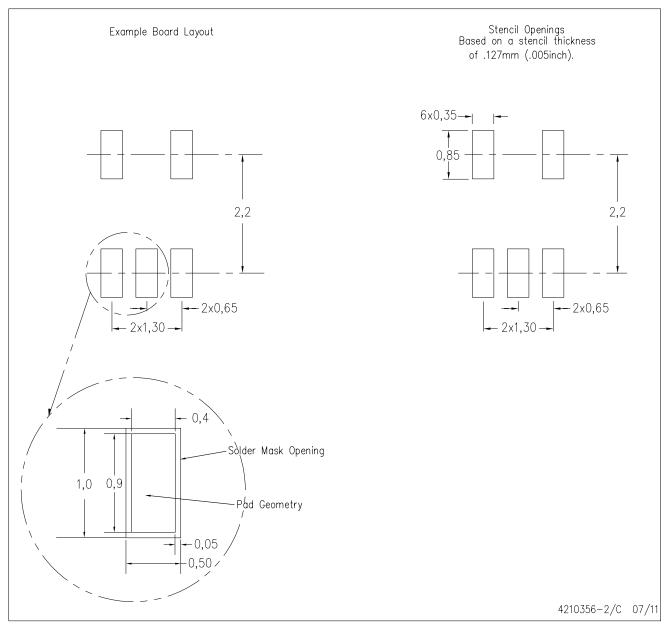
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AA.



DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



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